

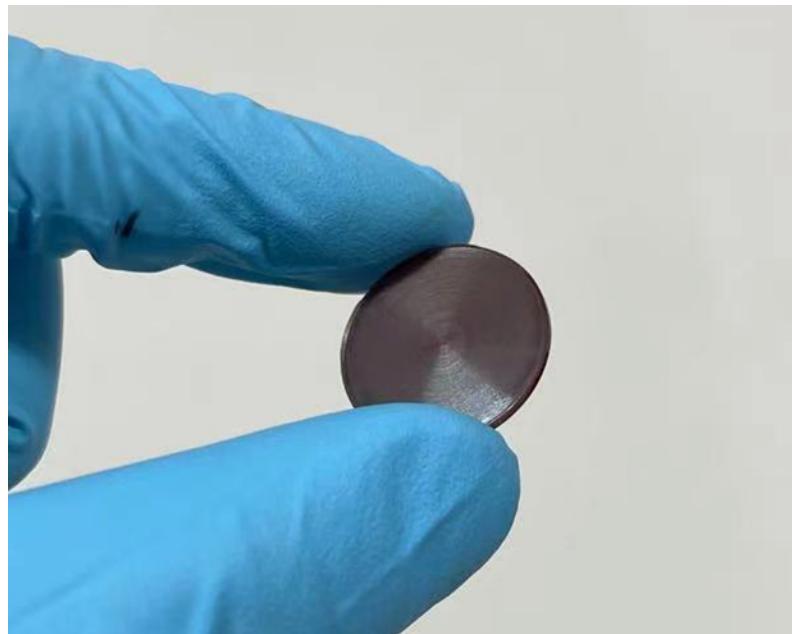
## Supplemental Information

# Inch-size $\text{Cs}_3\text{Bi}_2\text{I}_9$ polycrystalline wafer with near-intrinsic properties for ultralow-detection-limit X-ray detection

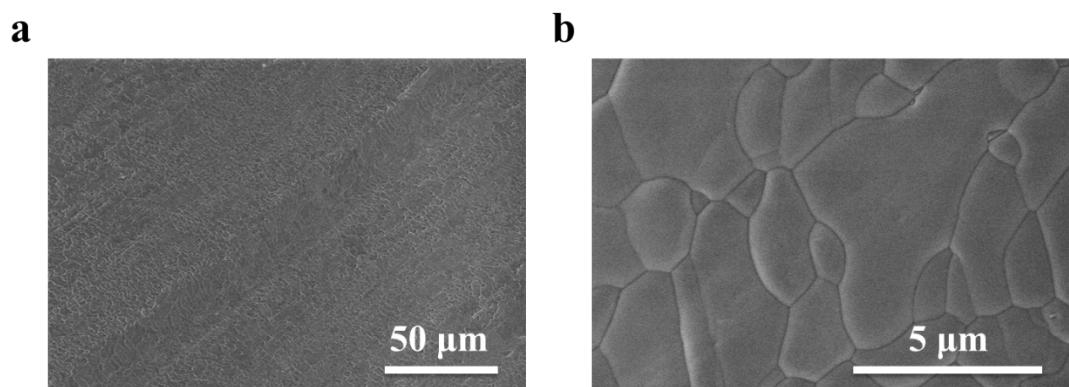
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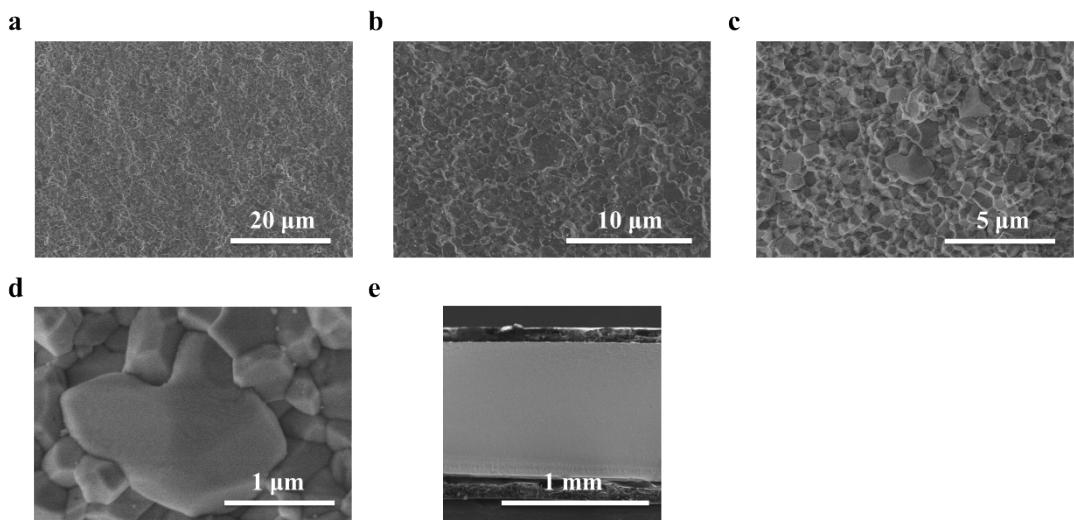
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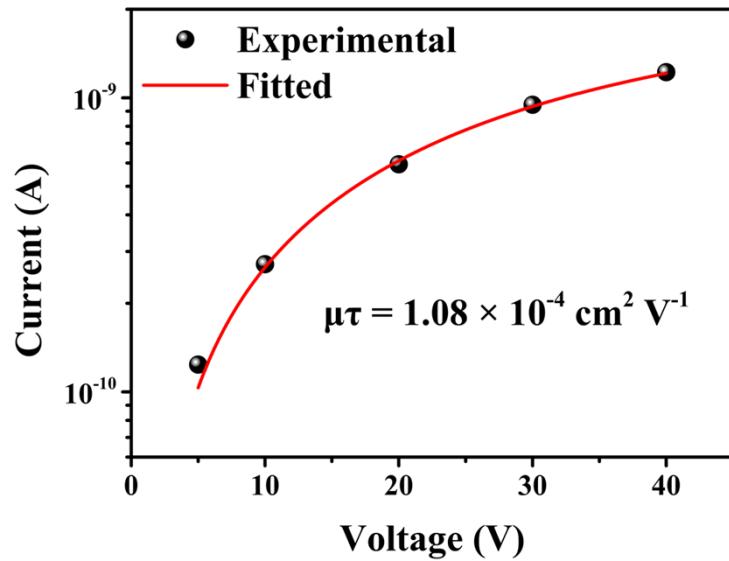
**Figure S1.** Photograph of the  $\text{Cs}_3\text{Bi}_2\text{I}_9$  wafer.



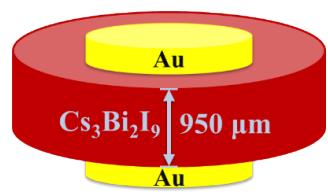
**Figure S2.** (a) and magnified (b) plan-view SEM image of the  $\text{Cs}_3\text{Bi}_2\text{I}_9$  wafer.



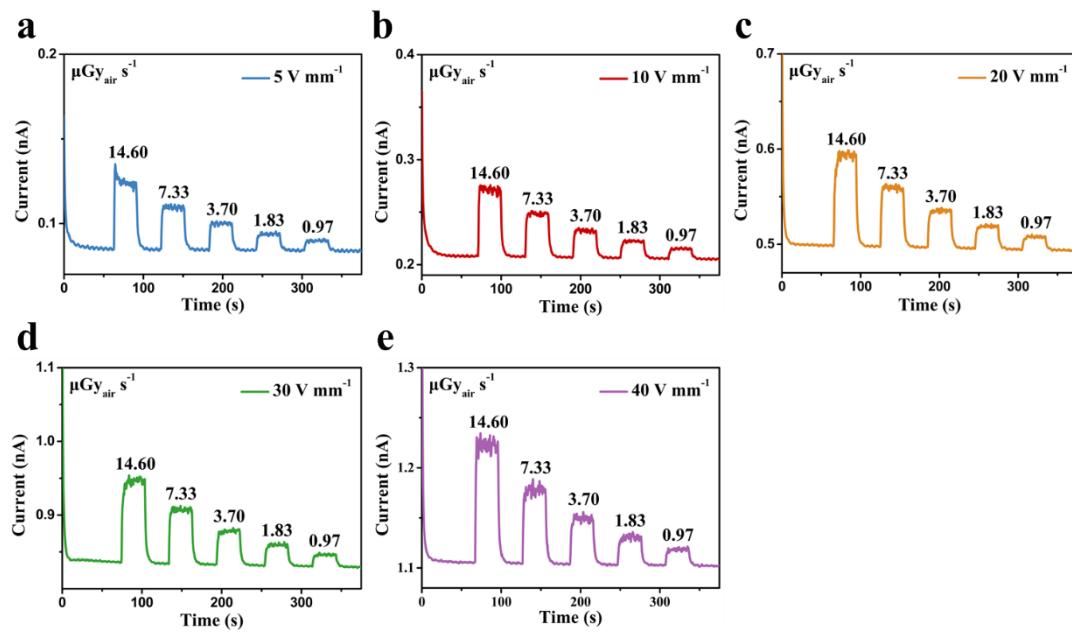
**Figure S3.** (a-e) Cross-sectional SEM images of the  $\text{Cs}_3\text{Bi}_2\text{I}_9$  wafer with different magnification.



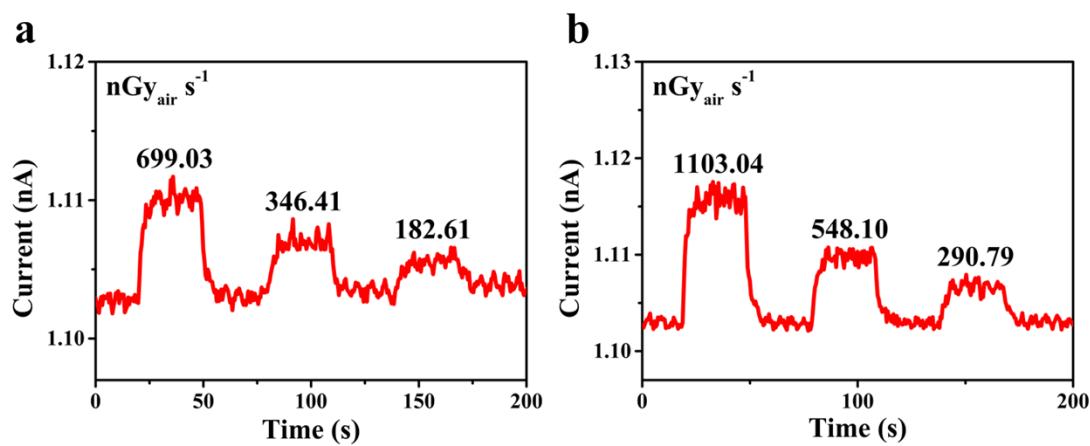
**Figure S4.** The fitted response current under X-ray illumination to determine the  $\mu\tau$  product.



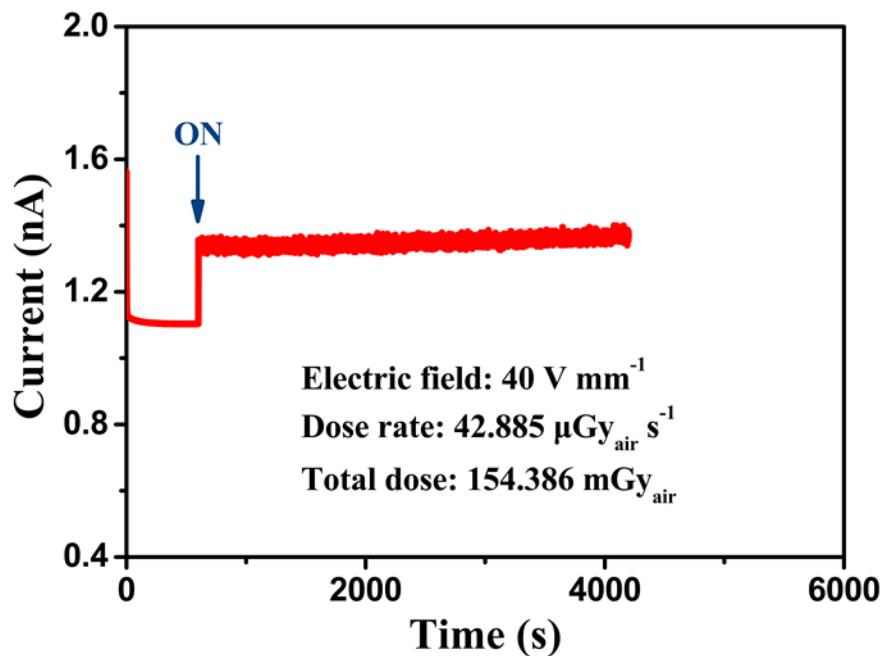
**Figure S5.** Schematic of the  $\text{Cs}_3\text{Bi}_2\text{I}_9$  polycrystalline-based X-ray detector structure.



**Figure S6.** (a-e) ON/OFF photocurrent response of  $\text{Cs}_3\text{Bi}_2\text{I}_9$  polycrystalline-based X-ray detector at different dose rates ( $0.97, 1.83, 3.70, 7.33$  and  $14.60 \mu\text{Gy}_{\text{air}} \text{s}^{-1}$ ) and different electric field ( $5, 10, 20, 30, 40 \text{ V mm}^{-1}$ ).



**Figure S7.** (a, b) I-T photocurrent response of the  $\text{Cs}_3\text{Bi}_2\text{I}_9$  X-ray detector under  $40 \text{ V mm}^{-1}$  electric field and various dose rates.



**Figure S8.**  $\text{Cs}_3\text{Bi}_2\text{I}_9$  X-ray detector operational stability against continuous X-ray irradiation under a dose rate of  $42.885 \mu\text{Gy}_{\text{air}} \text{s}^{-1}$  with  $40 \text{ V mm}^{-1}$  electric field.

**Table S1.** The X-ray detection performance of the lead-free perovskite detectors.

Materials	Source	Electric Field	Sensitivity	Detection limit	Ref
			( $\mu\text{C Gy}_{\text{air}}^{-1} \text{cm}^{-2}$ )		
Cs <sub>2</sub> AgBiBr <sub>6</sub> Single Crystal	50 kV	/	105 (25 V mm <sup>-1</sup> )	59.7 (2.5 V mm <sup>-1</sup> )	1
(BA) <sub>2</sub> CsAgBiBr <sub>7</sub> Single Crystal	70 keV	5 V mm <sup>-1</sup>	4.2	/	2
Cs <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Single Crystal	40 kV	50 V mm <sup>-1</sup>	1652.3	130	3
Cs <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Single Crystal	/	/	964 (120 V mm <sup>-1</sup> )	44.6 (60 V mm <sup>-1</sup> )	4
Cs <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Single Crystal	80 kV	450 V cm <sup>-1</sup>	111.9	/	5
Cs <sub>3</sub> Bi <sub>2</sub> Br <sub>9</sub> Single Crystal	50 kV	/	230.4 (200 V)	/	6
Rb <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Single Crystal	50 kV	300 V mm <sup>-1</sup>	159.7	8.32	7
MA <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Single Crystal	40 kV	60 V mm <sup>-1</sup>	1947	83	8
FA <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Single Crystal	45 kV	/	598.1 (500 V)	200 (180 V)	9
(NH <sub>4</sub> ) <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Single Crystal	50 keV	/	$8.2 \times 10^3$	55	10
(H <sub>2</sub> MDAP)BiI <sub>5</sub> Single Crystal	70 keV	5 V mm <sup>-1</sup>	~1	/	11
(DMEDA)BiI <sub>5</sub> Single Crystal	50 kV	494 V mm <sup>-1</sup>	72.5	/	12
Cs <sub>2</sub> AgBiBr <sub>6</sub> Wafer	50 keV	0.5 V mm <sup>-1</sup>	250	93.6	13
Cs <sub>3</sub> Bi <sub>2</sub> Br <sub>3</sub> I <sub>6</sub>	/	/	~2 (200 V)	10700 (50 V)	14
MA <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Wafer	45 kV	2100 V cm <sup>-1</sup>	563	9.3	15
(F-PEA) <sub>3</sub> BiI <sub>6</sub> Wafer	120 kV	100 V mm <sup>-1</sup>	118.6	30	16
Ba <sub>2</sub> AgIO <sub>6</sub> Wafer	50 keV	5 V mm <sup>-1</sup>	18.9	/	17
Cs <sub>3</sub> Bi <sub>2</sub> I <sub>9</sub> Wafer	40 kV	40 V mm <sup>-1</sup>	230.46	61.25	This work

Remarks: kV: tube voltage; keV: energy of electron after acceleration voltage.

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